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SIST EN 62769-7:2015

01-november-2015

Naprave in združevanje v proizvodne sisteme - Vključitev procesne naprave (FDI) - 7. del: Komunikacijske naprave (IEC 62769-7:2015)

Devices and integration in enterprise systems; Field Device Integration - Part 7: Communication Devices (IEC 62769-7:2015)

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Ta slovenski standard je istoveten z: EN 62769-7:2015

ICS:

25.040.40	Merjenje in krmiljenje industrijskih postopkov	Industrial process measurement and control
35.240.50	Uporabniške rešitve IT v industriji	IT applications in industry

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EUROPEAN STANDARD

NORME EUROPÉENNE

EUROPÄISCHE NORM

EN 62769-7

June 2015

ICS 25.040.40; 35.100

English Version

Field Device Integration (FDI) - Part 7: FDI Communication Devices (IEC 62769-7:2015)

Intégration des appareils de terrain (FDI) - Partie 7: Appareils de communication FDI (IEC 62769-7:2015)

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European foreword

The text of document 65E/350/CDV, future edition 1 of IEC 62769-7, prepared by SC 65E “Devices and integration in enterprise systems” of IEC/TC 65 “Industrial-process measurement, control and automation" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN 62769-7:2015.

The following dates are fixed:

• latest date by which the document has to be implemented at national level by publication of an identical national standard or by endorsement	(dop)	2016-03-16
• latest date by which the national standards conflicting with the document have to be withdrawn	(dow)	2018-06-16

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Annex ZA
(normative)

Normative references to international publications with their corresponding European publications

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 When an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: www.cenelec.eu.

Publication	Year	Title	EN/HD	Year
IEC 61804-3	-	Function Blocks (FB) for process control -- Part 3: Electronic Device Description Language (EDDL)	EN 61804-3	-
IEC 61804-4	-	Function blocks (FB) for process control -- Part 4: EDD interpretation	-	-
IEC 62541-4	-	OPC Unified Architecture - Part 4: Services	EN 62541-4	-
IEC 62541-6	-	OPC unified architecture - Part 6: Mappings	EN 62541-6	-
IEC 62541-7	-	OPC unified architecture - Part 7: Profiles	EN 62541-7	-
IEC 62541	series	OPC Unified Architecture	EN 62541	series
IEC 62541-100	-	OPC unified architecture - Part 100: Device Interface	EN 62541-100	-
IEC 62769-1	-	Devices and integration in enterprise systems; Field Device Integration - Part 1: Overview	-	-
IEC 62769-2	-	Devices and integration in enterprise systems; Field Device Integration - Part 2: FDI Client	-	-
IEC 62769-3	-	Devices and integration in enterprise systems; Field Device Integration - Part 3: FDI Server	-	-
IEC 62769-4	2015	Devices and integration in enterprise systems; Field Device Integration - Part 4: FDI Packages	-	-
IEC 62769-5	-	Devices and integration in enterprise systems; Field Device Integration - Part 5: FDI Information Model	-	-
IEC/TR 62541-1	-	OPC unified architecture - Part 1: Overview and concepts	CLC/TR 62541-1	-

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Edition 1.0 2015-05

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FIELD DEVICE INTEGRATION (FDI) –

Part 7: FDI Communication Devices

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International Standard IEC 62769-7 has been prepared by subcommittee 65E: Devices and integration in enterprise systems, of IEC technical committee 65: Industrial-process measurement, control and automation.

The text of this standard is based on the following documents:

CDV	Report on voting
65E/350/CDV	65E/420/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the 62769 series, published under the general title *Field Device Integration (FDI)*, can be found on the IEC website.

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INTRODUCTION

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a) Method for the Supplying and Installation of Device-Specific Functionalities, see Patent Family DE10357276;

b) Method and device for accessing a functional module of automation system, see Patent Family EP2182418;

c) Methods and apparatus to reduce memory requirements for process control system software applications, see Patent Family US2013232186;

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John Dilger, Emerson Process Management LLLP
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FIELD DEVICE INTEGRATION (FDI) –

Part 7: FDI Communication Devices

1 Scope

This part of IEC 62769 specifies the elements implementing communication capabilities called Communication Devices (IEC 62769-5).

The overall FDI architecture is illustrated in Figure 1. The architectural components that are within the scope of this document have been highlighted in this illustration. The document scope with respect to FDI Packages is limited to Communication Devices. The Communication Server shown in Figure 1 is an example of a specific Communication Device.

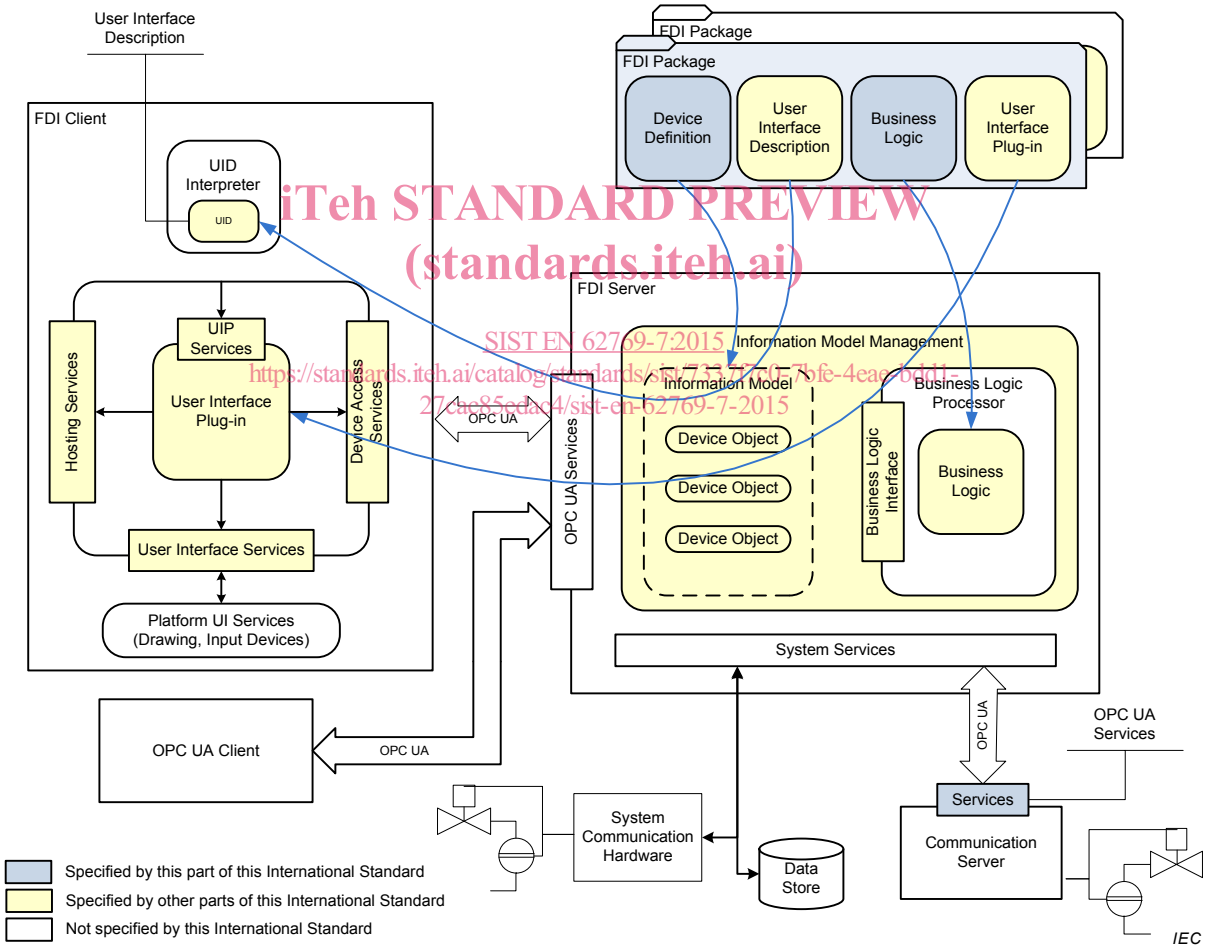

Figure 1 – FDI architecture diagram

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